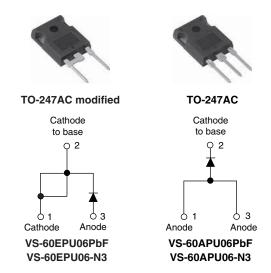
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**Vishay Semiconductors** 

## Ultrafast Soft Recovery Diode, 60 A FRED Pt<sup>®</sup>



PRODUCT SUMMARY									
Package	TO-247AC,								
Fackage	TO-247AC modified (2 pins)								
I <sub>F(AV)</sub>	60 A								
V <sub>R</sub>	600 V								
V <sub>F</sub> at I <sub>F</sub>	1.68 V								
t <sub>rr</sub> typ.	See Recovery table								
T <sub>J</sub> max.	175 °C								
Diode variation	Single die								

### **FEATURES**

- · Ultrafast recovery time
- · Low forward voltage drop
- 175 °C operating junction temperature
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)

#### **BENEFITS**

- Reduced RFI and EMI
- Higher frequency operation
- Reduced snubbing
- · Reduced parts count

#### **DESCRIPTION/APPLICATIONS**

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems.

The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

Pb-free
$\frown$



RoHS COMPLIANT HALOGEN FREE

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Cathode to anode voltage	V <sub>R</sub>		600	V
Continuous forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 116 °C	60	
Single pulse forward current	I <sub>FSM</sub>	T <sub>C</sub> = 25 °C	600	А
Maximum repetitive forward current	I <sub>FRM</sub>	Square wave, 20 kHz	120	
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 175	°C

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-					
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 60 A	-	1.35	1.68	v				
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 125 °C	-	1.20	1.42					
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 175 °C	-	1.11	1.30					
Deverse leakage everent		$V_{R} = V_{R}$ rated	-	-	50					
Reverse leakage current	I <sub>R</sub>	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$ -		-	500	μA				
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	39	-	pF				

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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)											
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS					
Reverse recovery time		$I_F = 1 \text{ A}, dI_F/dt = 20$	00 A/µs, V <sub>R</sub> = 30 V	-	34	45					
	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	81	-	ns				
		T <sub>J</sub> = 125 °C		-	164	-					
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	l <sub>F</sub> = 60 A dl <sub>F</sub> /dt = 200 A/µs	-	7.4	-	А				
		T <sub>J</sub> = 125 °C	$V_{\rm R} = 200 \text{ V}$	-	17.0	-	A				
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	300	-	nC				
		T <sub>J</sub> = 125 °C		-	1394	-					

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	0.63	K/W				
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.2	-	r\/ VV				
Weight			-	5.5	-	g				
Weight			-	0.2	-	oz.				
Mounting torque			1.2 (10)	-	2.4 (20)	N ⋅ m (lbf ⋅ in)				
Marking davias		Case style TO-247AC modified		60EPU06						
Marking device		Case style TO-247AC								

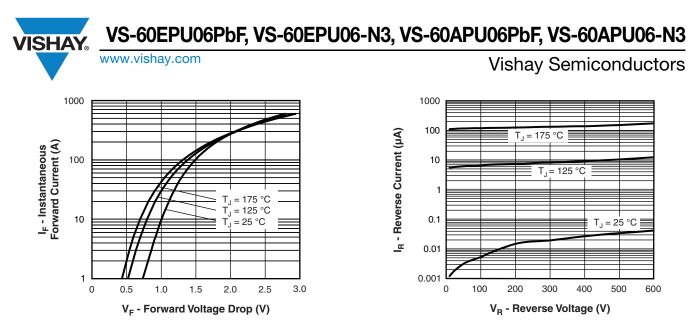


Fig. 1 - Typical Forward Voltage Drop Characteristics

Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

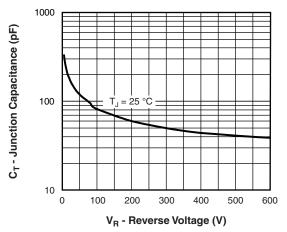


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

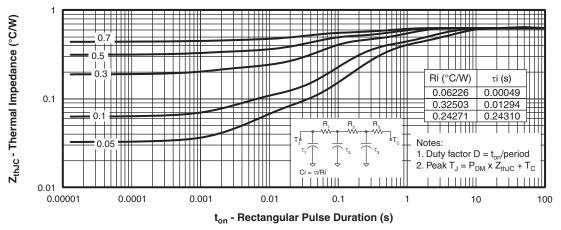


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

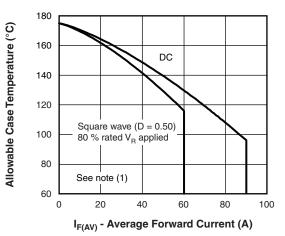
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Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

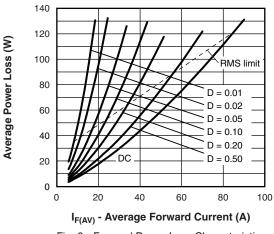
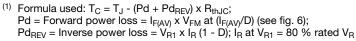


Fig. 6 - Forward Power Loss Characteristics

#### Note



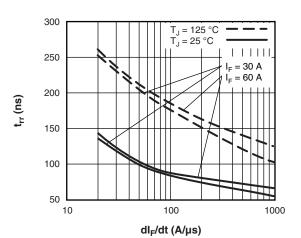


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

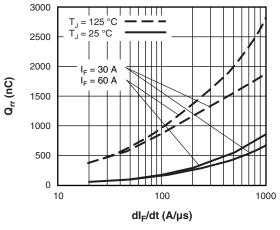


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

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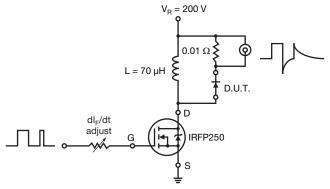


Fig. 9 - Reverse Recovery Parameter Test Circuit

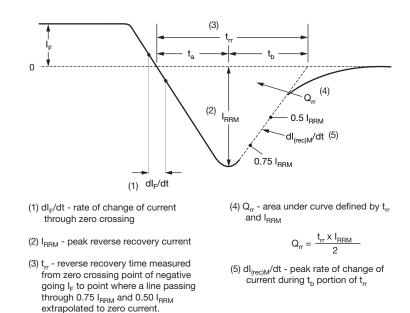


Fig. 10 - Reverse Recovery Waveform and Definitions

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### **Vishay Semiconductors**

### **ORDERING INFORMATION TABLE**

Device code	VS-	60	Е	Р	U	06	PbF
		2	(3)	4	(5)	(6)	(7)
		$\bigcirc$	$\bigcirc$	nicondu	$\bigcirc$	$\bigcirc$	$\bigcirc$
	2		-	ing (60 =	-	Judot	
	3	- Cire	cuit conf	iguratio	n:		
		• E	= Singl	e diode			
	_	• A	= Singl	e diode,	3 pins		
	4		kage:				
				7AC (mo	odified)		
	5	- Тур	e of sili	con:			
	_			st recov	-		
	6	- Vol	tage rat	ing (06 =	= 600 V)	)	
	7			ntal digit			
				d (Pb)-fr			-
		-N3	3 = Halo	gen-free	e, RoHS	compli	ant and

**ORDERING INFORMATION** (Example) **QUANTITY PER T/R PREFERRED P/N** MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION VS-60EPU06PbF 25 500 Antistatic plastic tube 25 VS-60EPU06-N3 500 Antistatic plastic tube VS-60APU06PbF 25 500 Antistatic plastic tube VS-60APU06-N3 25 500 Antistatic plastic tube

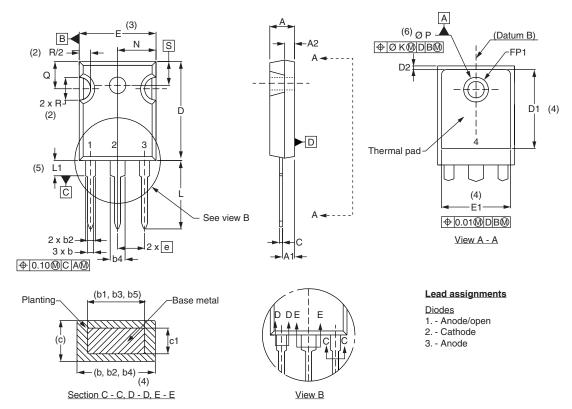
LINKS TO RELATED DOCUMENTS									
Dimensions	TO-247AC modified	www.vishay.com/doc?95253							
	TO-247AC	www.vishay.com/doc?95223							
	TO-247AC modified PbF	www.vishay.com/doc?95255							
Part marking information	TO-247AC modified -N3	www.vishay.com/doc?95442							
Part marking information	TO-247ACPbF	www.vishay.com/doc?95226							
	TO-247AC-N3	www.vishay.com/doc?95007							

### **Outline Dimensions**





### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES		SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STNIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209			D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.50	2.49	0.059	0.098			E1	13.72	-	0.540	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			FK	2.	54	0.0	)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.37	0.065	0.094			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133			ΦP	3.56	3.66	0.14	0.144	
с	0.38	0.86	0.015	0.034			Φ <b>P1</b>	-	6.98	-	0.275	
c1	0.38	0.76	0.015	0.030			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3	]	R	4.52	5.49	1.78	0.216	
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC	

#### Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

(6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

<sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c

Revision: 16-Jun-11

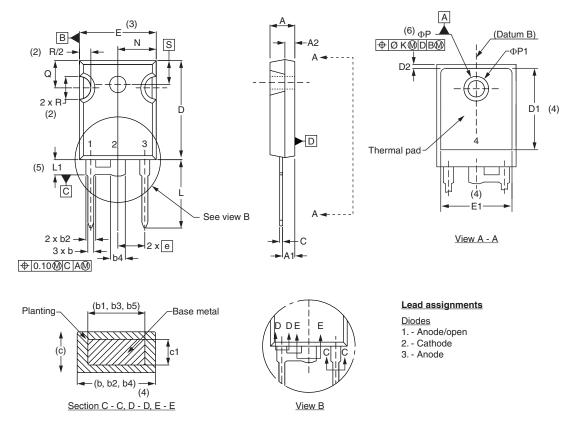
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### **Outline Dimensions**





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SYMBOL	MILLIM	IETERS	INC	HES	NOTES		SYMBOL	MILLIN	IETERS	INC	HES	NOTES		
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A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3		
A2	1.50	2.49	0.059	0.098			E1	13.72	-	0.540	-			
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC			
b1	0.99	1.35	0.039	0.053			ΦK	2.	54	0.0	)10			
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634			
b3	1.65	2.37	0.065	0.094			L1	3.71	4.29	0.146	0.169			
b4	2.59	3.43	0.102	0.135			N	7.62 BSC		N 7.62 BSC		0	.3	
b5	2.59	3.38	0.102	0.133			ΦР	3.56	3.66	0.14	0.144			
С	0.38	0.86	0.015	0.034			Φ <b>P1</b>	-	6.98	-	0.275			
c1	0.38	0.76	0.015	0.030			Q	5.31	5.69	0.209	0.224			
D	19.71	20.70	0.776	0.815	3		R	4.52	5.49	1.78	0.216			
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC			

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1

Document Number: 95253

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